



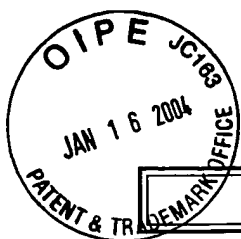
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Electronic Patent Application Submission
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EFS ID: 53870
Application ID: 10662248
Title of Invention: NEAR CHIP SIZE
SEMICONDUCTOR PACKAGE
First Named Inventor: Sean Crowley
Domestic/Foreign Application: Domestic Application
Filing Date: 2003-09-15
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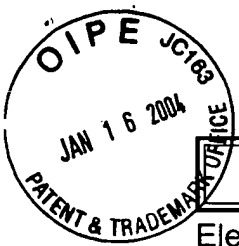


TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0


Title of Invention	NEAR CHIP SIZE SEMICONDUCTOR PACKAGE									
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Date: 2003-09-15										
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Attorney Docket Number: AMKOR036C										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>Mark B. Garred Registered Number: 34,823</td><td>/mbg/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	Mark B. Garred Registered Number: 34,823	/mbg/	Attorney		
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<table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>ids1-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			Documents being submitted	Files	us-ids	ids1-usidst.xml		us-ids.dtd		us-ids.xsl
Documents being submitted	Files									
us-ids	ids1-usidst.xml									
	us-ids.dtd									
	us-ids.xsl									
Comments										



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

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	8	4289922	1981-09-15	DEVLIN
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	50	5218231	1993-06-08	KUDO

US Published Applications

Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
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	2	20010014538	2001-08-16	KWAN ET AL.			
	3	20010011654	2002-01-31	KIMURA			
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	9	20030030131	2003-02-13	LEE ET AL.			
	10	20030073265	2003-04-17	HU ET AL.			

Signature

Examiner Name	Date